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Managing Technology Push through Marketing Testbeds: The Case of the Hi-Tech Center in Vienna, Austria

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Managing Technology Push through Marketing Testbeds: The Case of the Hi-Tech Center in Vienna, Austria

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PICMET '15

August 2-6, 2015
Portland Hilton
Portland, Oregon, USA

Abstract

The 'technology push' approach to technology development rests on the assumption that if you make it, they will come. This assumption carries significant market risk. The technology may miss its intended market window, or the market that was anticipated at the inception of technology development no longer exists at the time of market release.

This paper discusses how the Hi-Tech Center in Vienna, Austria, a multi-national collaborative effort between industry and universities in Central Europe, helps its clients manage technology push by deploying the marketing testbed approach. After identifying lead users for a client's technology, it characterizes and determines optimal market entry dates and windows of opportunity; readiness for and resistance to adoption; technology acceptance and marketability; and best practices for market entry.

The Hi-Tech Center learned the following overarching lesson from engaging with six clients in six different industries: marketing testbeds comprise an effective toolkit for managing technology push, primarily because they act as a link between the technology readiness level and the market readiness level. Thus they provide early insight into the customer's willingness to pay, the degree of fit between key features of the technology and marketability criteria, and, by extension, potential return on investment.

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HiTECH Zentrum in der grenzüberschreitenden Region



- The authors would like to thank the Hi-Tech Center in Vienna, Austria and six anonymous firms within Central Europe for sharing data that contributed to this paper.
- The Hi-Tech Center is a multi-national, multi-regional industry-university partnership.
- It is funded by the European Union's fund for regional development and by various local government agencies.
- Hi-Tech Center members include the Technical University of Vienna; the Economics University of Bratislava and Vienna University of Economics and Business.



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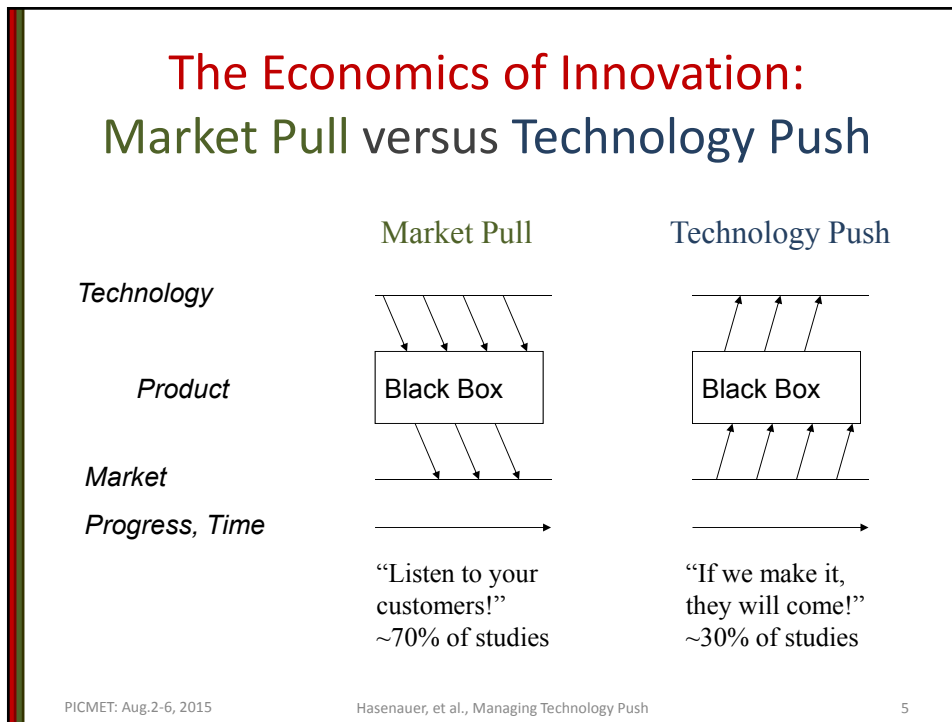
Outline

- Technology Push versus Market Pull
- Technology Readiness versus Market Readiness
- The Hi-Tech Center in Vienna, Austria
- Marketing Testbeds (MTBs)
- Evidence from Hi-Tech Center
 - Data from 26 companies
 - Six completed projects in six different industries
- Lessons Learned
- Future Applications
- Summary

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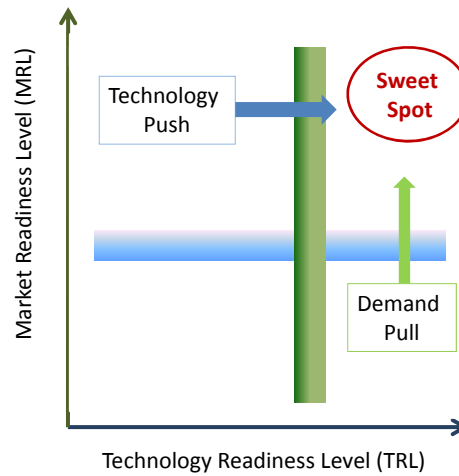
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- ## The Challenges of Technology Push
- If we make it, will they really come?
 - We have the technology! Will they really need it?
 - For what could they use our technology?
 - Who are ‘they’, anyway?
 - **Significant market risk!**
 - Technology may miss its intended market window.
 - Anticipated market may no longer exist at time of release.
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Key Questions



- Is the market ready for the technology?
- Is the technology ready for the market?

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Readiness Levels [1]

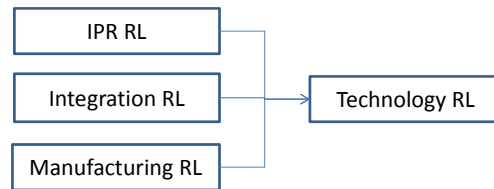
- **TRL – Technology Readiness Level**
 - expresses the degree of a technology
 - to be used safely
 - by intended and educated users
 - in the envisaged commercial (market)
 - or non-commercial user environment.
- **MRL – Market Readiness level**
 - measures the maturity of a given need
 - in the market considering
 - the potential obstacles.

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Technology Readiness Level (TRL)



- Consists of three components (*see Appendix A & B*):
 - Intellectual property readiness
 - Has IP been protected?
 - Does the firm have the right to operate without restrictions?
 - Integration readiness
 - Can technologies be integrated?
 - Manufacturing readiness
 - Can product be manufactured?

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Stages of Technology Readiness [2]-[4]

<u>Level</u>	<u>Technology Readiness</u>
1	Fundamental research
2	Applied research
3	Research to prove feasibility
4	Laboratory demonstration
5	Technology development
6	Whole system field demonstration
7	Industrial prototype
8	Product Industrialization
9	Market / sales certification

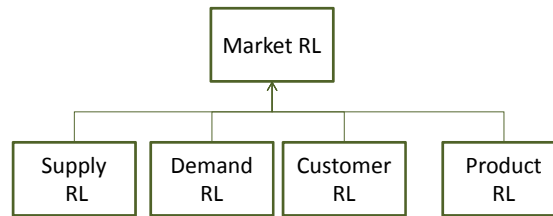
- *Measurement of readiness level is done by checking if the criteria used to describe the level are fulfilled.*

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Market Readiness Level (MRL)



- Consists of four components:
 - Supply readiness
 - To what degree are competitors' products available?
 - Demand readiness
 - What is the demand for the product?
 - Customer readiness
 - Is the customer ready to use and adopt the product?
 - Product readiness
 - Is the product ready for widespread use?

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Stages of Market Readiness [5], [6]

<u>Level</u>	<u>Market Readiness</u>
1	Unsatisfied needs have been identified
2	Identification of the potential business opportunities
3	System analysis and general environment analyzed
4	Market research
5	Target defined
6	Industry analysis
7	Competitors analysis and positioning
8	Value proposition defined
9	Product/service defined
10	Business model defined coherently*

- *Measurement of readiness level is done by checking if the criteria used to describe the level are fulfilled.*

*Added by KIC InnoEnergy (see [7], p. 20)

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The Hi-Tech Center

(www.hitechcentrum.eu)



- Multi-national collaborative effort between local industry and universities in Central Europe
- Directly deals with issues of technology push
- Funded by EU Regional Development Fund and local governments
- Provides the following services for regional startup firms and firms with high tech products:
 - Market research services
 - Preparation of marketing strategies
 - Support for high tech start-up companies
 - Specific market research tasks and business development

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The Hi-Tech Center's Approach: *The Marketing Testbed (MTB)*

- A service for technology-driven firms
- Finds and characterizes markets for emerging technologies
 - Measures *market readiness* and *technology readiness*
- Helps companies manage technology push

“This activity addresses the need of technology companies to validate the need for their product and its business case.” [8]

- MTB is practiced in telecom industry (S. Korea & Israel)
- Novelty in most high tech industries

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Marketing Testbed (ctd.)

- Analogous to but different from usability testbed
- Focuses on marketing tools (*Appendix C*)
 - Marketing mix
 - 4Ps
 - **Product**: technology- & product acceptance
 - **Pricing**/willingness to pay
 - **Promotion**: Marketing communication
 - **Place**: Sales and distribution channels

Objectives of Testbed Approach

- Characterize and determine
 - Identify lead users [9]
 - Market entry date and window of opportunity [10]
 - Readiness for and resistance to adoption [11]
 - Technology acceptance and marketability [12]
 - Market entry for high tech innovation [10]-[13]
 - Marketing management methods for high tech products [10]-[14]

Market Research and Analysis Methods

- Problem-centered interview (PCI) [15]
- Analytical hierarchy process (AHP) [16], [17]
- MCDM (multi criteria decision making) [18]
 - especially in B2B markets
- Technology acceptance
 - by perceived usefulness (PU)
 - and perceived ease of use (PEoU)

Technology Push/Market Entry Projects

(2013-2014)

<u>ID</u>	<u>Innovation</u>	<u>Entry</u>	<u>Industry</u>
A	Gesture controlled mmi	2014	scanner
B	Technical simulation	2014	software
C	Atmospheric nitrogen deposition collector	2014	sensor
D	Aerosol jet-printing	2014	3d printing
E	Selective Laser Melting	2014	3d printing
F	Sensors for mobile robots	2014	sensor
G	Health CCPM	2013	robotics
H	Safety Robot	2013	robotics
I	Atmospheric plasma for wood surface energy	2013	material science
J	Phase change material	2013	building construction
K	Flame retardant rubber	2013	material science
L	Magic lens augmented reality	2013	software
M	Bone diagnostics	2013	medical diagnosis

Technology Push/Market Entry Projects (2011-2012)

<u>ID</u>	<u>Innovation</u>	<u>Entry</u>	<u>Industry</u>
N	Continuous Non-Invasive Blood-Pressure Measurement	2012	medical diagnosis
O	'Watch dog' for semiconductor	2012	software
P	Containment	2012	building construction
R	Lab on chip diagnostics	2012	software
S	Vibrational acoustic analysis	2012	medical diagnosis
T	Smart bottling plant	2011	machine construction
U	Bright red systems	2011	scanner
V	mmi pressure and temperature sensors	2011	sensor
W	Bionic surface	2011	material science
X	Cellular materials	2011	material science
Y	V-REDOX	2011	energy storage
Z	Diamond-like carbon	2011	material science

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Readiness of 26 Technology Push Projects (2014)

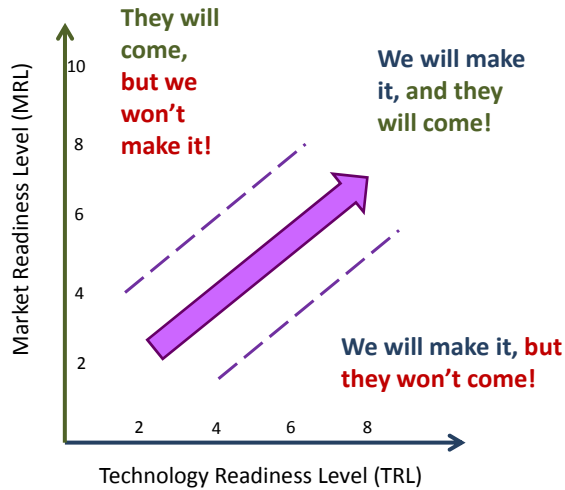
Market Readiness	Level	Technology Risk								
Building the adapted answer to the expressed need in the market	9						L;		H;	
Identification of the Experts possessing the competencies	8					Q;U;	B;		J;K;	Y;
Definition of the necessary and sufficient competencies and resources	7									
Translation of the expected functionalities into needed capabilities to build the response	6					O;	M;T;	P;		
Identification of system capabilities	5				Z;	A;				
Quantification of expected functionalities	4	W;		F;V;	R;	N;	E;			
Identification of the expected functionalities for new product/service	3		S;	X;	C;	G;	D;			
Identification of specific need	2	I;								
Occurrence of feeling "something is missing"	1									
	Level→	1	2	3	4	5	6	7	8	9
	Technology Readiness	Fundamental research	Applied Research	Research to prove feasibility	Laboratory Demonstration	Technology Development	Whole system Field demonstration	Industrial Prototype	Product Industrialisation	Market / Sales Certification

Market Risk

- Please see Appendix D for more detailed scores.

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Lessons Learned #1: Stay on the Diagonal!



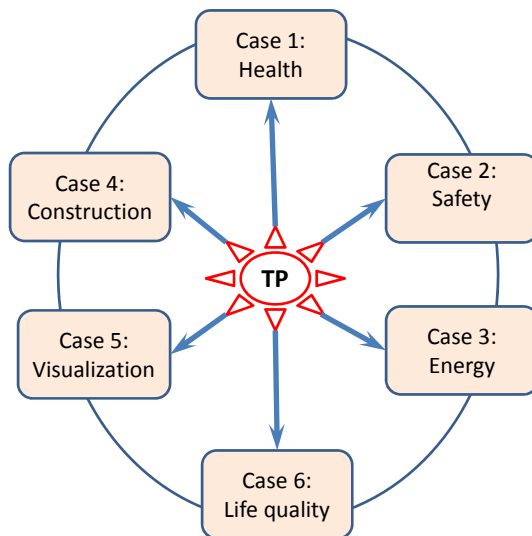
- Concurrent, step-by-step market and technology development places the right product into the right market window at the right time.

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Six Selected MTB Cases for Tech. Push



- All in B2B markets
- Marketing testbed process complete
- For case 4 MRL=2; TRL=3.
- For all others, TRL≥7; MRL≥7.

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Technology Push—Case M1: CCPM Robot for Rehabilitation

- Technology: Continuous compliant passive motion (CCPM)
- For medical applications
 - Initial application: rehabilitation after shoulder surgery
- MTB Activity:
 - Intensive market research
 - Analysis of competitors and technology acceptance
 - First clinical study was successful.
- Unique selling proposition (USP):
 - High compliance of the robot
 - towards patients' pain expectation
 - (Robot uses efficient acceleration sensors.)
- Target Market: orthopedic hospitals / doctors

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Technology Push—Case 2: Safety/Security Robot

- Unmanned guided vehicle
 - Dedicated to hazardous missions
 - Waterproof, 'ruggedized' and ATEX certified
 - Intuitive control system and multipurpose interfaces
- Key area of application: Coal mining missions
 - Communication in real time is critical.
- MTB focused on evaluation of
 - perceived usefulness
 - perceived ease of use under human guidance
 - robot-robot cooperation in open air

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Technology Push—Case 3: Building Insulation

- Thermal insulation using phase change material (PCM)
 - based on BASF Micronal®
- Application:
 - Intelligent temperature management for buildings
 - Significant energy savings
- MTB focused on value chain
 - from building physicists, architects, civil engineers, energy planner to building owner
 - Willingness to pay analysis showed clear preferences
 - Technology acceptance analysis performed
 - Usability requirements tested
 - Industrial standards evaluation showed market resistance

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Technology Push—Case 4: Plasma Glue

- Technology replaces glue by surface energy
 - Influences surface energy of wood
 - by atmospheric plasma (Dielectric Barrier Discharge DBD)
 - Improves adhesive forces by a factor of 1.5 to 2
 - Reduces quantity of glue required by up to 50%
 - Speeds up of physical drying by a factor of 2
 - The effects vary with type of wood, wood fiber orientation, impregnation and type of glue.
 - For some combinations no effect was detectable.
- Application: multi-layered boards for construction.
- MTB:
 - Identified early customers;
 - Technical stress tests for a variety materials, voltages and levels of humidity
- Further experimental evidence is needed.

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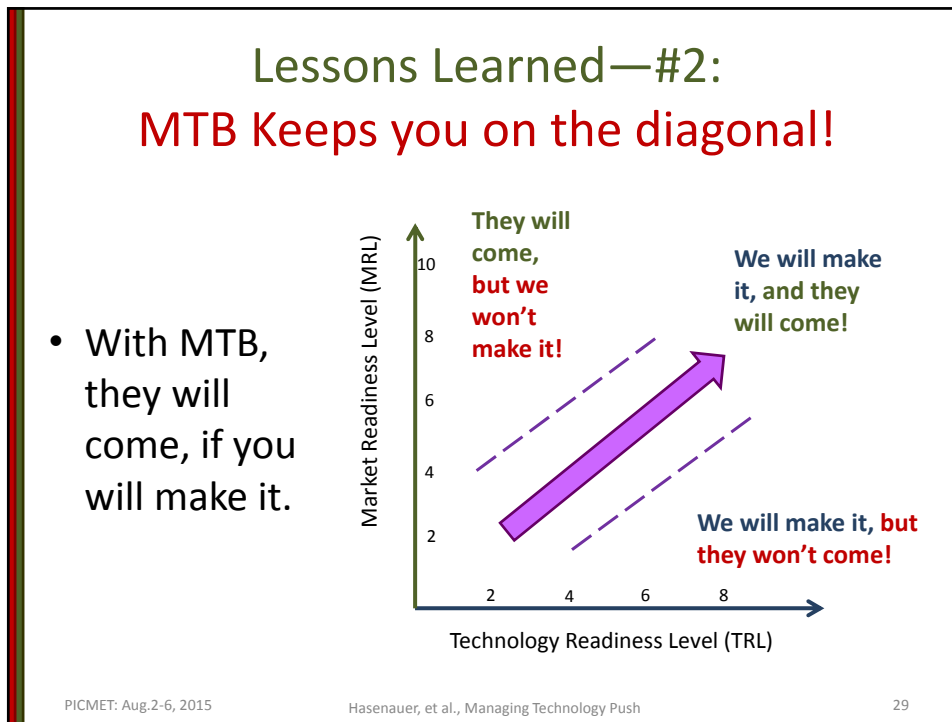
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Technology Push—Case 5: Magic Lens

- Tablet application
 - recognizes objects
 - in a live camera image
 - and adds additional information
 - using augmented reality
- Communicates features of a product more effectively.
- Use cases: trade shows, sales talks and show rooms
- Example: “Most important, USP is a process, happens inside the product. Magic lens visualizes in real time.”
- Convincing by understanding generates trust
- MTB process identified new customers and tested how sophisticated they were.
- Further details see <http://www.magiclensapp.com>

Technology Push—Case 6: V-REDOX

- Vanadium sulfate reduction oxidation (V-REDOX)
 - Flow battery technology enabling and
 - Suited for stationary Remote Area Power Supply (RAPS)
 - Can be coupled with photovoltaics and wind power
 - Low self discharge, high longevity of electrolyte, safe.
- Improves quality of human life in remote areas.
- MTB analyzed
 - Technology acceptance and fulfillment of marketability criteria
 - Volatility of raw material prices of electrolyte
 - Business model variants



- ### Lesson Learned—#3: About the Marketing Testbed Process
1. Most frequent challenge: given a technology => where is the market?
 2. Understand technology prototype and early customer demand in the customers' language
 3. Characterize the problem solving capacity for Problem X
 4. Identify potential users who have Problem X
 5. Explore their technology acceptance, their marketability requirements (incl. standards), WTP and their readiness to assimilate new technology [13]
 6. Act as a "translator" from customers demand into technology supply. (Multidisciplinary communication/ Buying Center)
 7. Average manpower for MTB job: 3 pers. @ 160 hrs./pers.
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Lessons Learned—#4:

About Technology Push in B2B Markets

- Overall Readiness is an integrated concept
 - Consists of Technology -, Market - and Societal- Readiness.
- Interface between push and pull
 - Requires deep mutual understanding
 - Of supply and demand at the technology frontier.
- Pricing strategy:
 - Matching solution space with benefit space (iterative process)
 - Translate benefits into monetary terms
- Having reached TRL=4,
 - Start approaching latent/emergent markets
 - Develop valid understanding of their technological problems.
 - Behind each bottleneck is a latent market. [18]

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Lessons Learned—#5:

Return on Investment

- ROI depends on Time to Market, customer's WTP and sustainable technology leadership.
- Technology Push ROI-risk is reduced by staying concurrently in alignment with latent/emerging markets,
- Look out for competitors

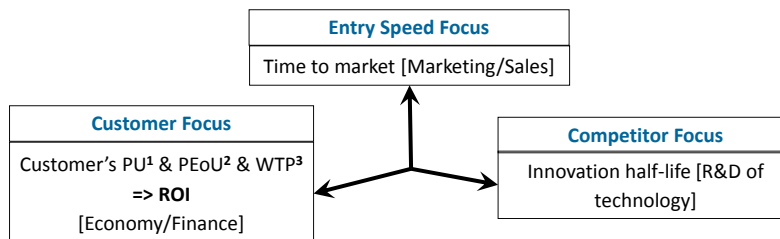
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Lessons Learned—#5: Return on Investment (ctd.)

- Return on investment is a tradeoff!



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Future Plans

- **CCPM:** European quality certificate and multi-site testing
- **Safety Robot:** Conquer new markets
- **Building Insulation:**
 - Conquer European markets
 - Export to USA.
- **Plasma:** More applications testing (1 year +)
- **Magic Lens:** Export to USA; found US subsidiary.
- **V-Redox:** Introduction to US Market (buffer batteries)
- **Hi-Tech Center** plans to
 - Become a private company that specializes in MTB service
 - Collaborate with incubators and venture funds

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Summary

- Technology-driven firms develop highly innovative technology that is looking for new markets
- Marketing testbed studies identify and characterize these markets
- They bridge the gap between suppliers/innovators and users/customers
- Technology enters more markets.
- Time to market is reduced.
- Flop risk is reduced.
- ***This paper has shown that the MTB approach to managing technology push is applicable to many technologies made by firms in many industries.***

Q&A

Thank you for your attention!

Additional non-confidential data for MTB studies on the technologies under study are available upon request. Some are presented in the appendixes.

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Appendix A:

Clarification of Additional Terms [1]-[4]

- **MFRL – Manufacturing Readiness Level**
 - identifies the preparedness of the manufacturer
 - to develop the manufacturing process
 - and to assess the risk and feasibility
 - of a given technology.
- **IRL--Integration Readiness Level**
 - describes the difficulties
 - of progressing through TRL scale
 - and choosing between / combining
 - competing alternative technologies.
- **IPR RL - Intellectual Property Right Readiness Level**
 - Covers issues such as patenting, research agreements and collaboration agreements that impact IP ownership.

Readiness Levels

APPENDIX B

Integration Readiness Levels

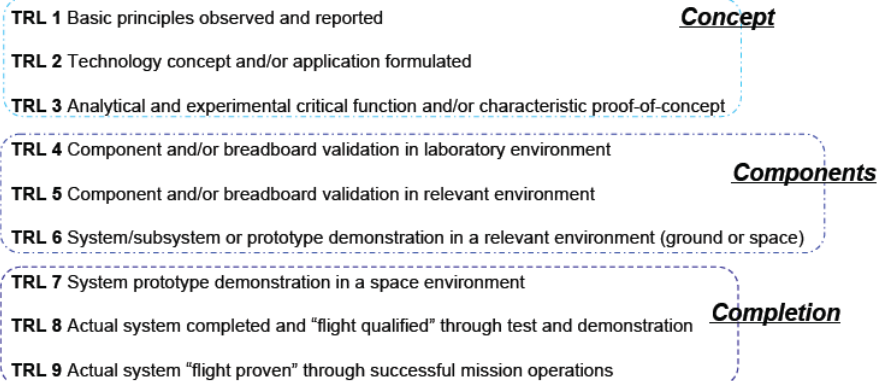
[6], [20]

Level **Action Performed**

- 1 An Interface between technologies has been identified with sufficient detail to allow characterization of the relationship
- 2 There is some level of specificity to characterize the Interaction (i.e. ability to influence) between technologies through their interface.
- 3 There is compatibility (i.e. common language) between technologies to orderly and efficiently integrate and interact
- 4 There is sufficient detail in the quality and assurance of the integration between technologies.
- 5 There is sufficient control between technologies necessary to establish, manage, and terminate the integration
- 6 The integrating technologies can accept, translate, and structure information for its intended application.
- 7 The integration of technologies has been verified and validated with sufficient detail to be actionable.
- 8 Actual integration completed and mission qualified through test and demonstration, in the system environment.
- 9 Integration is mission proven through successful mission operations.

Innovation Readiness Levels [21]

- Innovation Readiness Level (IRL) expresses the readiness of an organization to implement and safely use an innovation by intended and educated user.



Intellectual Property Readiness Level [22]

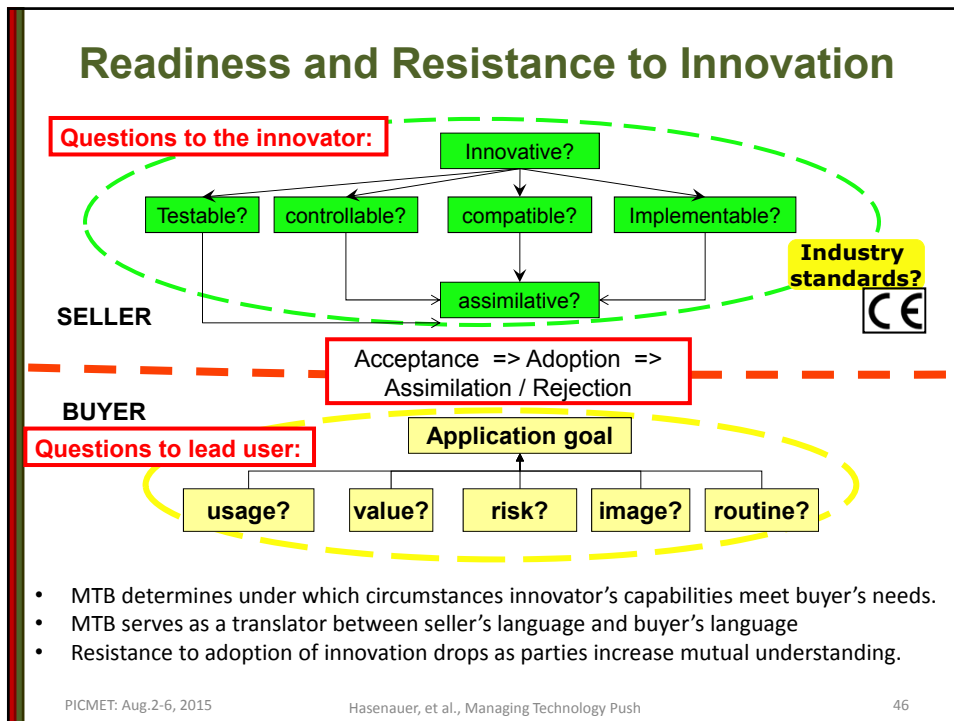
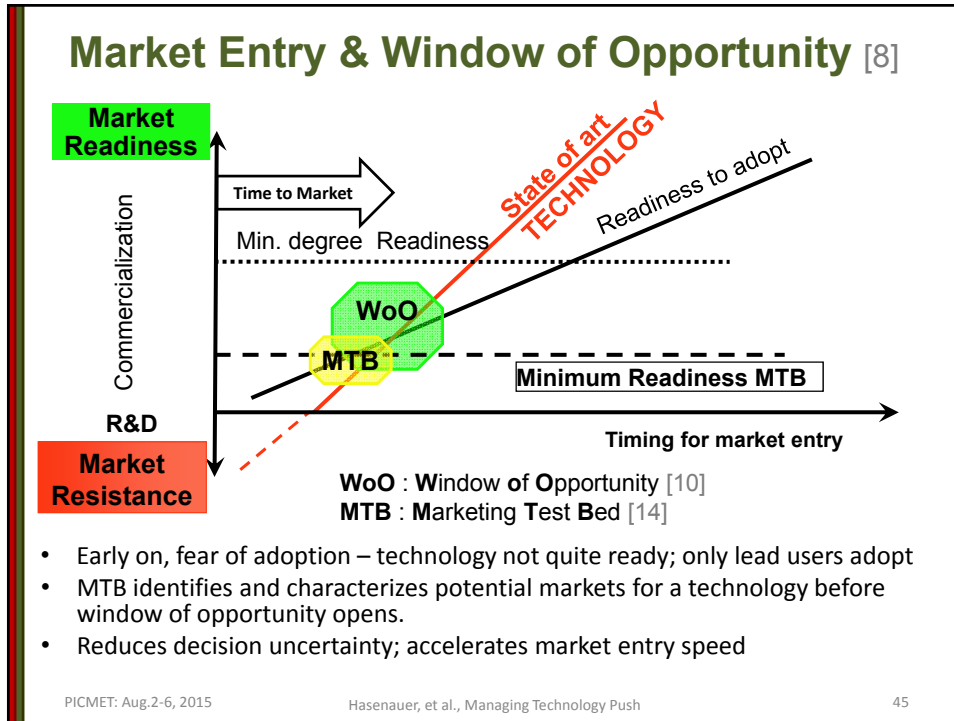
Level **Action performed**

- 1 Hypothesizing on possible IPR (patentable inventions)
- 2 Identified specific patentable inventions or other IPR
- 3 Detailed description of possible patentable inventions. Initial search of the technical field and prior art.
- 4 Confirmed novelty and patentability; decided on alternative IP protection if not patenting
- 5 First complete patent application filed, Draft of IPR strategy done.
- 6 Positive response on patent application; initial assessment of freedom to operate, patent strategy supporting business
- 7 Patent entry into national phase; other formal IPR registered
- 8 First patent granted, IPR strategy fully implemented, more complete assessment of freedom to operate
- 9 Patent granted in relevant countries, strong IPR support for business

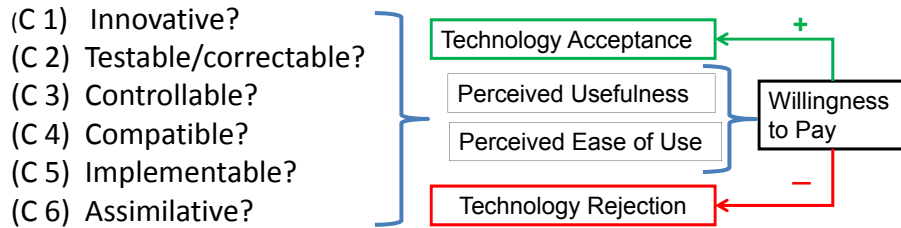
Marketing Testbeds

Theoretical Foundation [19]

APPENDIX C



High Tech Innovation: Criteria for Acceptance and Marketability



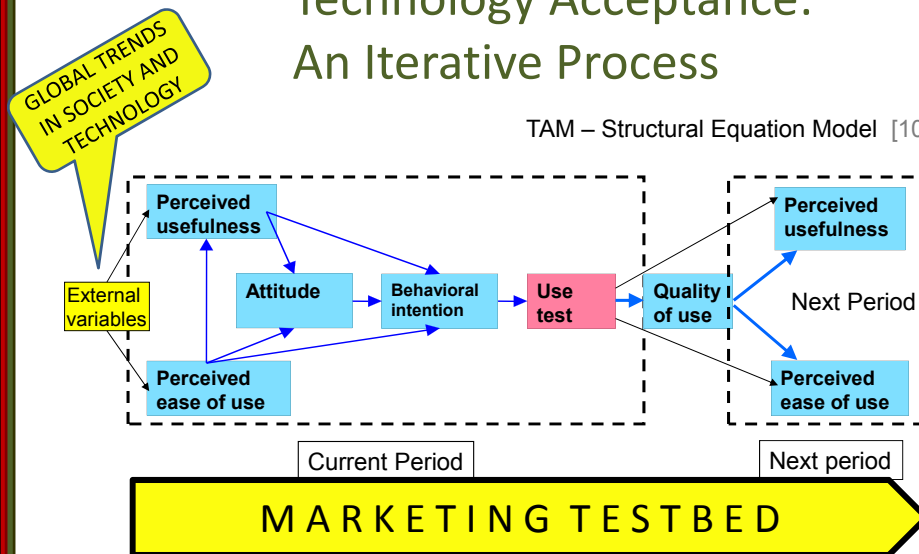
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Technology Acceptance: An Iterative Process

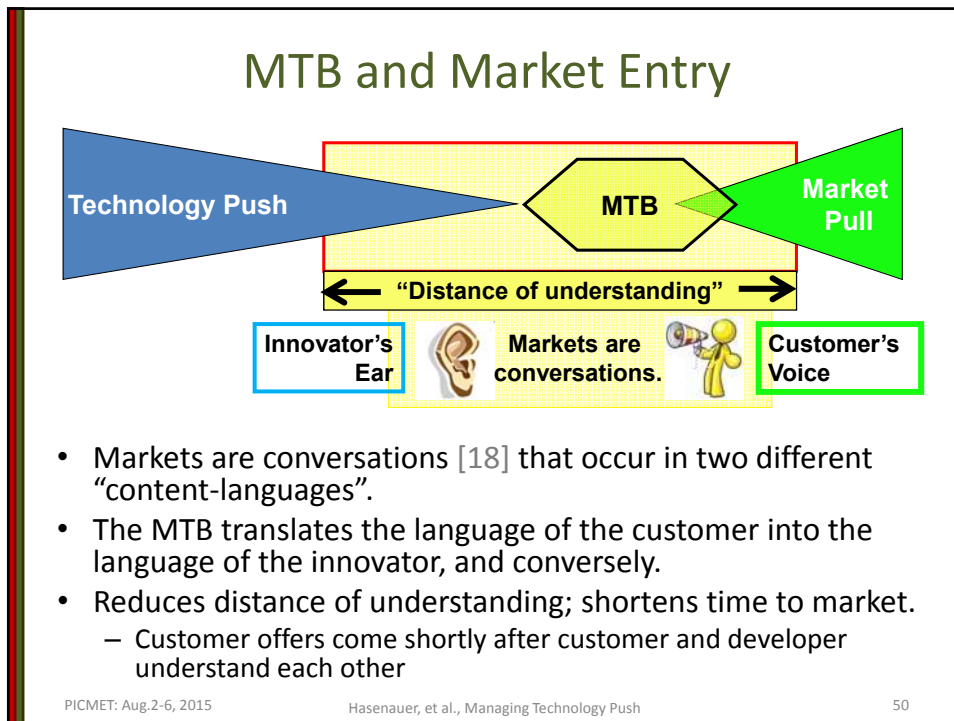
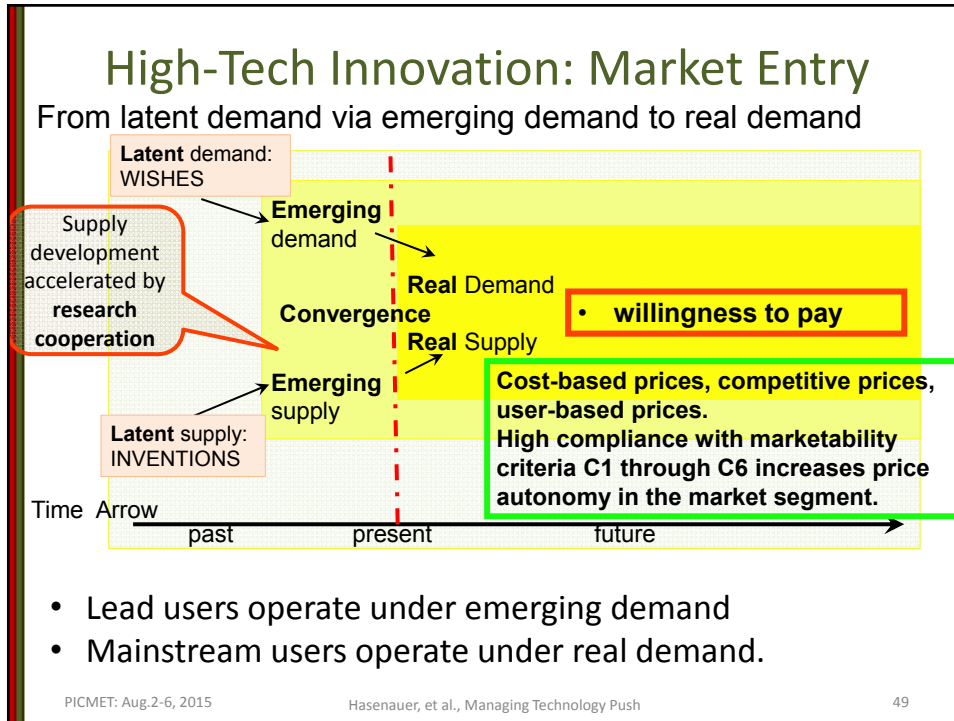
TAM – Structural Equation Model [10]

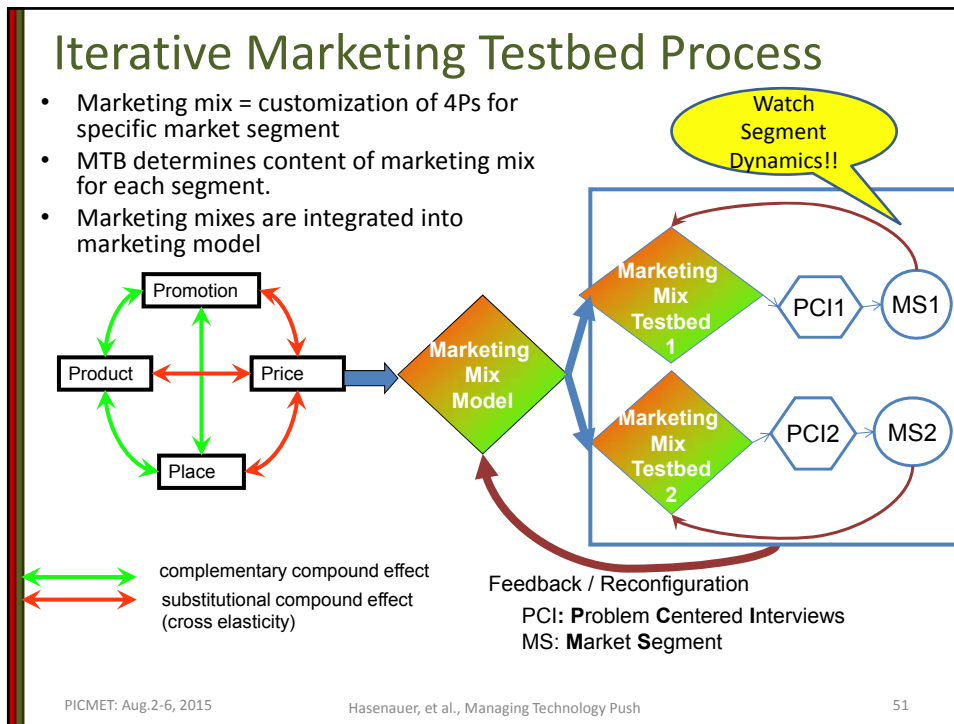


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Readiness Levels for 26 Projects

APPENDIX D

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Material Science Innovation/Medical Devices

Id	Innovation	year	industry	TECHNOLOGY					MARKET			
				Intellect Prop. Right- RL	Technology- RL	Integration RL	Manu- fact RL	MEAN	Demand RL	Custo- mer RL	Product RL	MEAN
I	atmospheric plasma for wood surface energy	2013	material science	2	3	2	2	2	2	3	2	2
K	flame retardant rubber	2013	material science	8	8	6	8	8	9	8	8	8
M	bone diagnostics	2013	medical diagnosis	6	6	5	5	6	8	6	4	6
N	Continuous Non-Invasive Blood-Pressure	2012	medical diagnosis	8	6	6	5	6	5	5	2	4
S	vibrational acoustic analysis	2012	medical diagnosis	3	3	3	2	3	4	4	2	3
W	bionic surface	2011	material science	2	3	2	2	2	4	4	3	4
X	cellular materials	2011	material science	4	4	3	5	4	4	3	3	3
Z	diamond like carbon	2011	material science	3	4	4	4	4	6	4	5	5

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Robotics & Sensors

Id	Innovation	year	industry	TECHNOLOGY					MARKET					
				Intellect Prop. Right- RL	Technology- RL	Integration RL	Manu- fact RL	SUM	MEAN	Demand RL	Custo- mer RL	Product RL	SUM	MEAN
C	atmospheric nitrogen deposition collector device	2014	sensor	3	6	4	6	19	5	4	3	3	10	3
F	New sensors for mobile robots	2014	sensor	3	4	3	5	15	4	4	4	3	11	4
G	Health CCPM	2013	robotics	8	6	5	6	25	6	4	4	2	10	3
H	Safety Robot	2013	robotics	8	9	8	7	32	8	9	8	9	26	9
V	mmi pressure and temperature sensors	2011	sensor	4	5	3	5	17	4	5	4	3	12	4

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Software, Sensor & 3D Printing

	Innovation	year	industry	TECHNOLOGY						MARKET				
				Intellect Prop. Right-RL	Technology-RL	Integration-RL	Manufact-RL	SUM	MEAN	Demand-RL	Customer-RL	Product-RL	SUM	MEAN
B	technical simulation	2014	software	3	8	6	7	24	6	9	8	8	25	8
C	atmospheric nitrogen deposition collector device	2014	sensor	3	6	4	6	19	5	4	3	3	10	3
D	Aerosoljet-printing	2014	3d printing	9	6	4	8	27	7	4	3	2	9	3
E	Selective Laser Melting	2014	3d printing	9	6	6	8	29	7	4	3	4	11	4
F	New sensors for mobile robots	2014	sensor	3	4	3	5	15	4	4	4	3	11	4
L	Magic Lens augmented reality	2013	software	2	8	6	8	24	6	9	9	9	27	9
O	watch dog for semiconductor	2012	software	3	6	5	7	21	5	7	6	5	18	6
R	lab on chip diagnostics	2012	software	8	4	3	4	19	5	5	5	2	12	4
V	mmi pressure and temperature sensors	2011	sensor	4	5	3	5	17	4	5	4	3	12	4